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U.S. DEPARTMENT OF COMMERCE

Patent and Trademark Office

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Docket No.:

To the Honorable Commissioner of Patents and Trademarks:	Please record the attached original documents or copy thereof.
Name of conveying party(ies):	2. Name and address of receiving party(ies):
Feng-Lung CHIEN Randy H. Y. LO Chun-Chi KE	Name: Siliconeware Precision Industries Co., Ltd. Address:
Additional names(s) of conveying party(ies)	No. 123, Sec. 3, Da Fong Road Tantzu
3. Nature of conveyance:	Taichung, Taiwan, R.O.C.
Assignment	ř 💆
☐ Security Agreement ☐ Change of Name	City: State/Prov.:
Other	Country: ZIP:
Execution Date: August 7, 2000	Additional name(s) & address(es)
4. Application number(s) or registration numbers(s): If this document is being filed together with a new application, Patent Application No. Filing date	the execution date of the application is: August 21, 2000 B. Patent No.(s) O9449319
Additional numbers	☐ Yes Ϫ No
5. Name and address of party to whom correspondence concerning document should be mailed:	6. Total number of applications and patents involved:
Name: Peter F. Corless	7. Total fee (37 CFR 3.41):\$
Registration No. 33,860 Address: Dike, Bronstein, Roberts & Cushman	Enclosed - Any excess or insufficiency should be credited or debited to deposit account 04–1105
Intellectual Property Practice Group of	Authorized to be charged to deposit account
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	PATENT

REEL: 011032 FRAME: 0972

ASSIGNMENT OF U.S. PATENT APPLICATION

	In consideration of the sum of One Dollar (\$1.00) in hand paid, and other good and valuable consideration, the receipt of which is hereby acknowledged, the undersigned
Inventor(s) Full Name(s)	(1) Feng-Lung CHIEN (2) Randy H.Y. LO (3) Chun-Chi KE
	•••••••••••••••••••••••••••••••••••••••
Assignee Name and Address	hereby sell, assign and transfer to SILICONWARE PRECISION INDUSTRIES CO., LTD.
	No. 123, Sec. 3, Da Fong Rd., Tantzu, Taichung, Taiwan, R.O.C.
	(hereinafter called the Assignee) the entire right, title, and interest in and to any and all improvements which are disclosed in the Application for United States Letters Patent entitled
Title of Invention	MEHTOD OF FORMING CIRCUIT PROBING CONTACT POINTS ON FINE PITCH PERIPHERAL BOND PADS ON FLIP CHIP
	which application was
Complete either 1) or b)	a) executed by the undersigned on the day of
	b) filed on the day of
	Serial No
	It is hereby authorized and requested that the Commissioner of Patents issue any and all of said Letters Patent. when granted, to said Assignee.
	Further, it is agreed that, when requested, without charge to but at the expense of said Assignee, the undersigned will execute all divisional, continuing, substitute, renewal, and reissue patent applications; execute all rightful other papers; and generally do everything possible which said Assignee shall consider desirable for aiding in securing and maintaining proper patent protection.
Date	Taiwan, R.O.C.
	this . 7.th. day of August
Inventor(s)	INVENTOR(S): Feng-Lung CHIEN
Full Signat ure (s)	INVENTOR(S): Feng-Lung Chien Randy H.Y. LO Chun Chi Ke Chun-Chi KE
	Chun-Chi KE
Witnesses'	WITNESSES:
Full Signatur es	

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PATENT REEL: 011032 FRAME: 0973